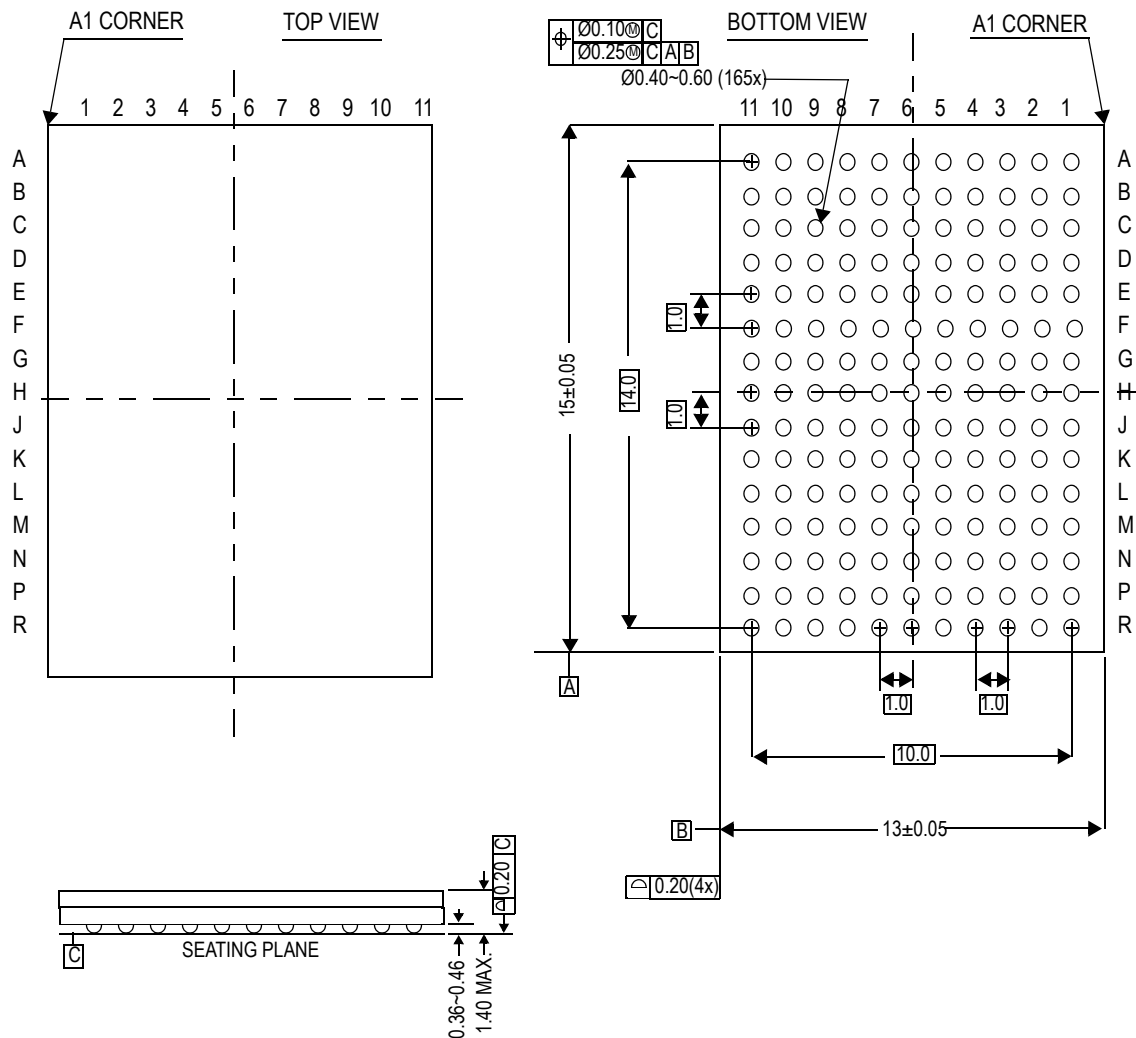


165-Bump BGA (13 mm x 15 mm) DummyDie™ Daisy Chain Package

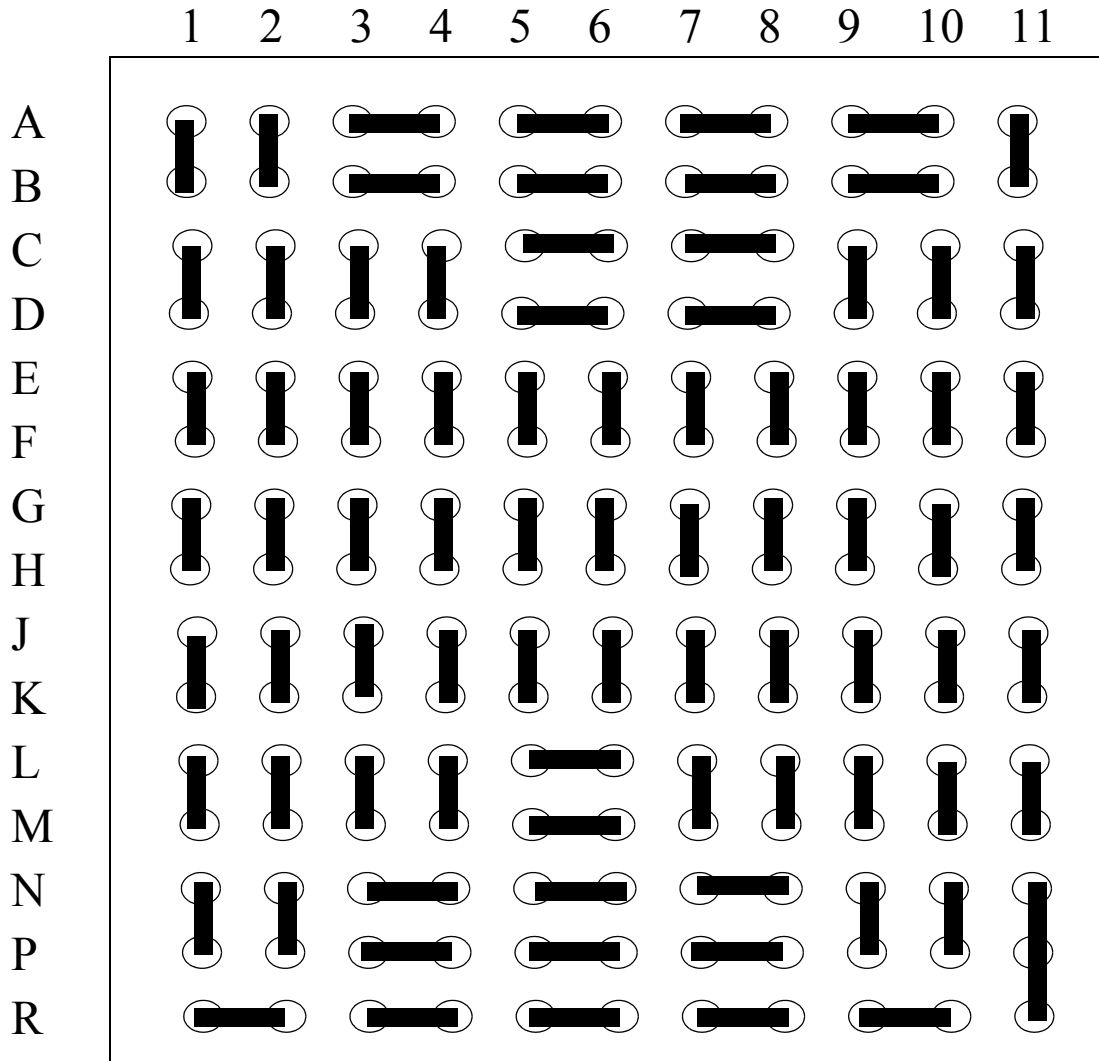
Description

This mechanical daisy chain test vehicle is designed to represent the 165-Bump BGA package. It is used for second level interconnect assembly test and continuity verification. The DummyDie™ incorporates a 10.77 mm x 12.20 mm die, which is not electrically connected.

Package Dimensions—165-Bump FPBGA (Package D)



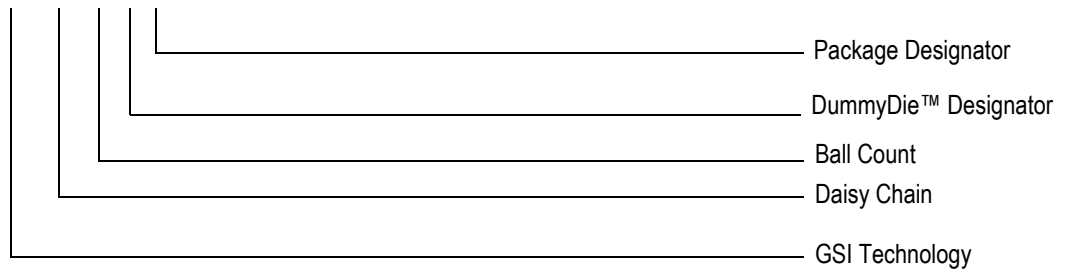
Package Dimensions—165-Bump FPBGA (Package D)



Ordering Information

**165-Bump BGA (13 mm x 15 mm)
Daisy Chain Package**

GSDC165DD



**165-Bump BGA (13 mm x 15 mm)
Daisy Chain Package
RoHS-compliant Option**

GSDC165DGD

